

Features

- Glass passivated junction chip
- Fast switching for high efficiency
- Low reverse leakage
- High surge capability
- Solder dip 260°C, 10s
- Built-in strain relief, high reliability



DO-214AC (SMA)

Typical Applications

For use of general purpose rectification in lighting, cellular phone, portable device, power suppliers and other consumer applications.

Absolute Maximum Ratings ($T_A=25^\circ\text{C}$ unless otherwise specified)

| Parameter | Symbol | Value | Unit |
|---|-----------------|-------------|----------------------|
| Maximum Repetitive Peak Reverse Voltage | V_{RRM} | 1600 | V |
| Maximum RMS Voltage | V_{RMS} | 1120 | V |
| Maximum DC Blocking Voltage | V_{DC} | 1600 | V |
| Maximum Average Output Rectified Current | $I_{F(AV)}$ | 1 | A |
| Peak Forward Surge Current 8.3ms Single Half Sine-Wave Superimposed on Rated Load | I_{FSM} | 30 | A |
| Rating for Fusing ($t < 8.3\text{ms}$) | I^2t | 3.74 | A^2s |
| Typical Thermal Resistance ¹ | $R_{\theta JA}$ | 90 | $^\circ\text{C/W}$ |
| | $R_{\theta JC}$ | 20 | $^\circ\text{C/W}$ |
| | $R_{\theta JL}$ | 25 | $^\circ\text{C/W}$ |
| Operating Junction Temperature Range | T_J | -65 to +150 | $^\circ\text{C}$ |
| Storage Temperature Range | T_{STG} | -65 to +150 | $^\circ\text{C}$ |

Electrical Characteristics ($T_A=25^\circ\text{C}$ unless otherwise noted)

| Parameter | Symbol | Conditions | Value | Unit |
|---|----------|---|-------|---------------|
| Maximum Instantaneous Forward Voltage | V_F | $I_F=1.0\text{A}, T_A=25^\circ\text{C}$ | 2.1 | V |
| Maximum DC Reverse Current at Rated DC Blocking Voltage | I_R | $T_A=25^\circ\text{C}$ | 3 | μA |
| | | $T_A=100^\circ\text{C}$ | 10 | |
| Maximum Reverse Recovery Time | t_{rr} | $I_F=0.5\text{A}, I_R=1.0\text{A}, I_{RR}=0.25\text{A}$ | 75 | nS |
| Typical Junction Capacitance | C_J | 4.0V, 1MHz | 15 | pF |

Notes: 1. The thermal resistance from junction to ambient, case and lead, mounted on FR-4 P.C.B with 5x5mm copper pads, 2OZ.

Ratings and Characteristics Curves

($T_A=25^\circ\text{C}$ unless otherwise noted)

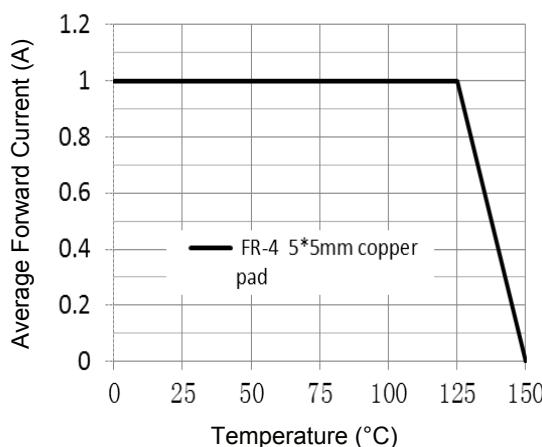


Figure 1. Forward Current Derating Curve

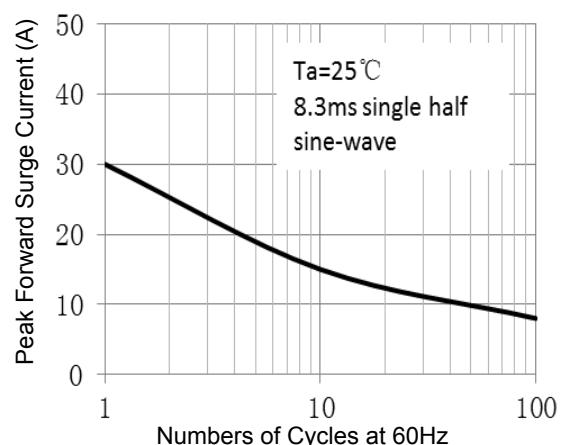


Figure 2. Maximum Non-Repetitive Peak Forward Surge Current

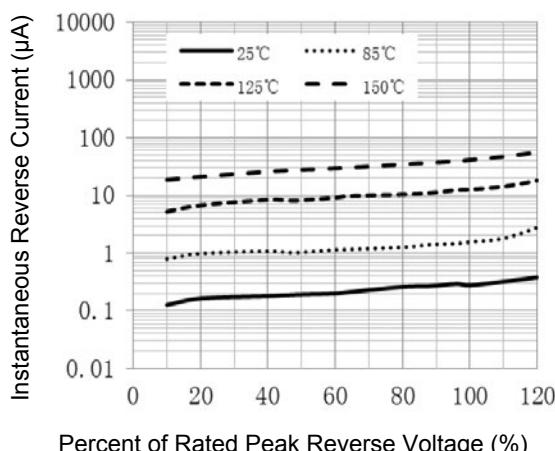


Figure 3. Typical Reverse Characteristics

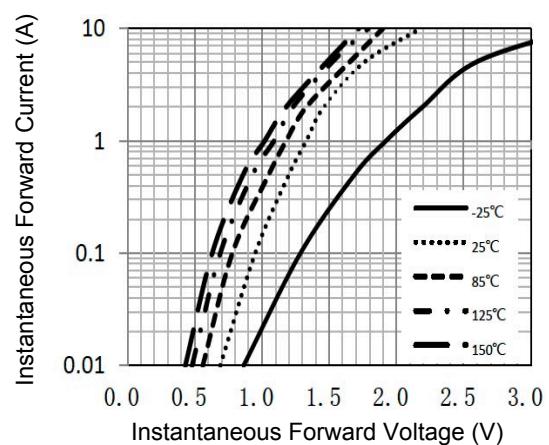


Figure 4. Typical Instantaneous Forward Characteristics

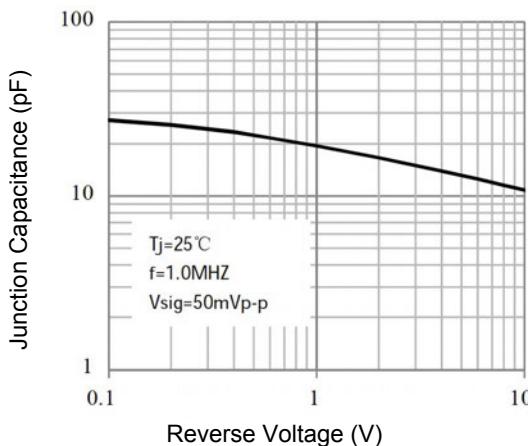
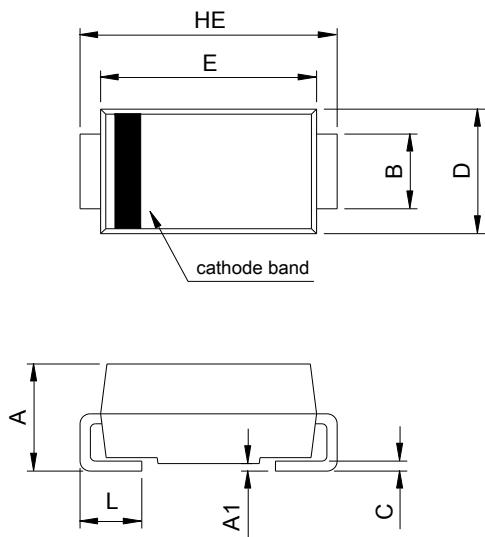


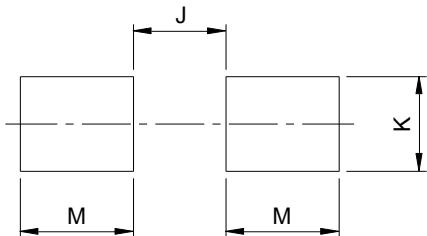
Figure 5. Typical Junction Capacitance

Package Outline Dimensions DO-214AC (SMA)



| SMA (DO-214AC) | | | | |
|----------------|-------------|------|--------|-------|
| DIM | Millimeters | | Inches | |
| | Min. | Max. | Min. | Max. |
| A | 1.90 | 2.30 | 0.075 | 0.091 |
| A1 | 0.00 | 0.20 | 0.000 | 0.008 |
| B | 1.25 | 1.65 | 0.049 | 0.065 |
| C | 0.15 | 0.31 | 0.006 | 0.012 |
| D | 2.35 | 2.90 | 0.093 | 0.114 |
| E | 3.99 | 4.60 | 0.157 | 0.181 |
| HE | 4.80 | 5.30 | 0.189 | 0.209 |
| L | 0.76 | 1.52 | 0.030 | 0.060 |

Recommended Pad Layout



| Recommended Pad Layout (Reference ONLY) | | | | |
|---|-------------|------|--------|-------|
| DIM | Millimeters | | Inches | |
| | Min. | Max. | Min. | Max. |
| J | - | 2.20 | - | 0.087 |
| K | 1.72 | - | 0.068 | - |
| M | 2.00 | - | 0.079 | - |